# Study of the Excitation Power Dependent Internal Quantum Efficiency in InGaN/GaN LEDs Grown on Patterned Sapphire Substrate

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Abstract—The mechanisms of the excitation power dependent internal quantum efficiency in InGaN/GaN multiple quantum wells (MQWs) LEDs grown on the planar and the patterned sapphire substrates (PSS) at temperature of 15 and 300 K were investigated. From observation the tendency of emission peak energy and carrier lifetime variation in MQWs with different excitation power for both LED samples, we conclude the internal quantum efficiency would increase as coulomb screening effect dominates at lower carrier injection stage and decrease due to the band-filling effect at higher density stage. At room temperature, the majority of the initial injected carriers would be first consumed by the thermal activated nonradiative centers that hinder the further achievement of high-efficiency LED devices. Experimentally, the internal quantum efficiency of the LED grown on the PSS is  $\sim 70\%$  and that of the LED grown on the planar sapphire substrate is  ${\sim}62\,\%.$  For the LED grown on the PSS, the observed higher internal quantum efficiency is due to the larger activation energy Therefore, the reduction of dislocation defects and the prevention of injected carriers escaping from extended states would be a promising prospective for InGaN/GaN MQWs LEDs to achieve high internal quantum efficiency.

Index Terms—LEDs, GaN, Internal quantum efficiency.

### I. INTRODUCTION

THE III-nitride material has attracted much attention due to its tremendous potential for fabricating LEDs with an emission range from UV to short visible wavelength [1], [2]. Indeed, III-nitride LEDs have been realized to a wide range of applications that include intelligent interior lighting, backlighting unit for liquid crystal display, and general lighting [3]. In general, the external quantum efficiency was used to evaluate LED performance and was defined as the product of internal quantum efficiency and light extraction efficiency. For an III-nitride LED, the internal quantum efficiency is determined primarily by growth and the associated defect formation [4].

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On the other hand, the extraction efficiency is limited by total internal reflection at the interface of GaN and air [5]. Therefore, for energy-saving reasons, an LED structure must be designed to yield either high internal quantum efficiency or high light extraction efficiency. As considering the large difference of the refractive index between GaN ( $n \sim 2.5$ ) and air, most emitted light are trapped inside the LED chip and approximately only 4% of that could be extracted from a surface [6]. Thus, most reported literature to date puts attention to develop high light extraction LED structures, such as surface roughening [7], [8], photonic crystal [9], [10], chip shaping [11], backside reflector [12], and so on. In contrast, the studies related to improve the internal quantum efficiency of III-nitride LEDs are relatively fewer. One of the reasons is the absence of a convincing approach to evaluate the internal quantum efficiency of LEDs. The general approach to evaluate the internal quantum efficiency of LEDs is to compare the photoluminescence (PL) intensity between low and room temperatures; however, the selection of pumping laser wavelength, power density, and temperature would profoundly affect the measured results. Recently, Watanabe et al. had proposed a method to determine the internal quantum efficiency of LEDs by performing excitation power density and temperature-dependent PL [13]. In comparison to the traditional measurement method, the proposed method is believed to be more accurate since the efficiency under different pumping density was considered. Based on their results, the variation of the internal quantum efficiency of InGaN/GaN LEDs with increasing excitation power at 11 and 300 K was observed. Nevertheless, the reason for causing that variation was not clearly discovered. It is so important to understand the physical mechanisms of emission process that enables us to find out a guideline to improve the internal quantum efficiency.

In this research, we measured the internal quantum efficiency of InGaN/GaN multiple quantum wells (MQW) blue LEDs grown on c-plane planar and patterned sapphire substrates (PSS) and investigated the physical mechanism behind by analyzing the emission energy, full-width at half maximum (FWHM) of the emission spectra, and carrier recombination dynamic by time-resolved photoluminescence (TRPL) measurement.

# II. EXPERIMENT

The etched patterns on sapphire substrate are 2-D hole-arrays arranged as hexagonal lattice with lattice constant of 7  $\mu$ m and hole diameter of 3  $\mu$ m. The etched hole is 0.5  $\mu$ m in depth and has triangular-shaped C-plane in the center, surrounded

by three {1–102} *R*-plane facets. The fabrication details of PSS can be found elsewhere [14], [15]. The LED structure was then grown on planar substrate and PSS by low-pressure metalorganic chemical vapor deposition.

## Injected Carrier Density

$$= \frac{P}{(h\nu) * \phi * d_{\text{active}} * f} * \exp(-\alpha_{\text{GaN}} d_{\text{GaN}})$$
$$* [1 - \exp(-\alpha_{\text{InGaN}} d_{\text{active}})] * (1 - R). \tag{1}$$

The LED structure consisted of a 30-nm-thick AlN nucleation layer, a 2- $\mu$ m-thick Si-doped n-type GaN, and an unintentionally doped active layer with  ${\rm In}_x{\rm Ga}_{1-x}{\rm N/GaN}$  MQWs, and a 0.2- $\mu$ m-thick Mg-doped p-type GaN. The doping concentration of n- and p-type GaN was nominally  $5\times 10^{18}$  and  $1\times 10^{19}$  cm<sup>-3</sup>, respectively. The MQW layers comprised 16 periods of an  ${\rm In}_{0.15}{\rm Ga}_{0.85}{\rm N}$  well ( $\sim 2$  nm) and a GaN barrier ( $\sim 16$  nm).

For excitation power and temperature-dependent PL measurement, the sample was mounted in a closed-cycle He cryostate and the temperature was controlled at 15 and 300 K. A frequency doubled femto-second-pulse Ti:sapphire laser of 390 nm was used to avoid the absorption of p-type GaN and directly examine the optical property of InGaN/GaN MQWs region. The luminescence signal dispersed through a 0.55-m monochromator was detected by the photomultiplier tube. The excitation power was changed from  $5 \times 10^{-3}$  mW to 80 mW, and the corresponded injected carrier density was about  $10^{13}$  to  $8 \times 10^{17}$  cm<sup>-3</sup>. In this research, to reflect the influence of the carrier density more clearly, the incident PL power was converted to the injected carrier density in all figures. The injected carrier density is determined primarily by the power of pumping laser (P), the energy of injected photon (hv), the spot size of pumping laser ( $\phi$ ), the thickness of GaN and active region ( $d_{\rm GaN}, d_{\rm active}$ ), the repetition rate of pumping laser (f), the absorption efficiency of GaN and InGaN ( $\alpha_{GaN}$ ,  $\alpha_{InGaN}$ ), and the reflectance of pumping laser (R), as expressed by the following equation [see (1), shown at the bottom of the page]. Experimentally, we choose  $\phi = 50 \ \mu \text{m}$ ,  $d_{\rm GaN} = 200$  nm,  $d_{\rm active} = 270$  nm,  $\alpha_{\rm InGaN} = 10^5$  cm<sup>-1</sup>, and R=0.17 to calculate the injected carrier density in our samples.

Here, we ignore the absorption of GaN, since the energy of pumping photons is less than its energy bandgap, i.e.,  $\alpha_{\rm GaN}=0$ . For the measurement of temperature dependent TRPL, the frequency doubled femto-second-pulse Ti:sapphire laser was operated on 390 nm with 2 mW. The repetition rate of the laser is 76 MHz whose time interval is 13 ns. The luminescence decay was measured with time correlated single photon counting system in conjunction with a 0.55-m monochromator. Time resolution for the detection is about 4 ps. The setup details of temperature dependent PL and TRPL are shown in Fig. 1.

# III. RESULTS AND DISCUSSION

Fig. 2 shows the measured power-dependent efficiency as a function of injected carrier density at 15 and 300 K for both LEDs grown on the planar sapphire substrate and PSS. The efficiency is defined as the collected photon number divided by the

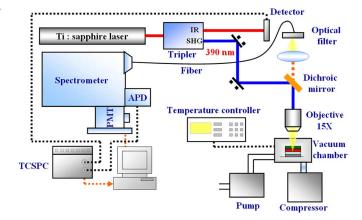


Fig. 1. Setup of temperature-dependent PL and TRPL to evaluate the internal quantum efficiency of LED samples.

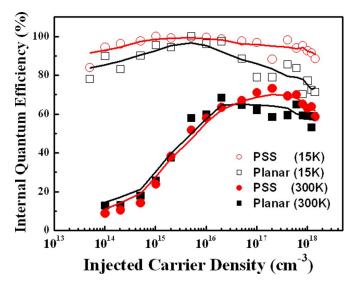


Fig. 2. Internal quantum efficiency as function of injected carrier density at 15 and 300 K for the LEDs grown on the planar sapphire substrate and the PSS.

injected photon numbers and all normalized to the maximum efficiency [13]. For the LED grown on planar sapphire substrate, one could clearly see that the internal quantum efficiency increases with injected carrier density to reach its maximum and decreases as the injected carrier density further increases. The tendency of two efficiency curves at 15 and 300 K is quite similar. But under low-injection carrier density range, the internal quantum efficiency at 300 K increases more pronounced than it at 15 K. Moreover, the corresponding density to the peak efficiency ( $\sim$ 62%) in 300 K is at injected carrier density of about  $10^{17}$  cm<sup>-3</sup>, which is lager than it at 15 K, about  $10^{16}$  cm<sup>-3</sup>. A much larger variation of the internal quantum efficiency was observed over the injection carrier range at 300 K than 15 K.

For the LED grown on the PSS, a similar dependence of the internal quantum efficiency on the injected carrier density was observed. However, in term of the peak efficiency ( $\sim\!70\%$ ) in 300 K at injected carrier density of  $1\times10^{17}~{\rm cm}^{-3}$ , the internal quantum efficiency of LED grown on the PSS was enhanced by  $\sim\!13\%$ . It means that under the same injected power of pumping laser, there is about 13% enhancement for the converted

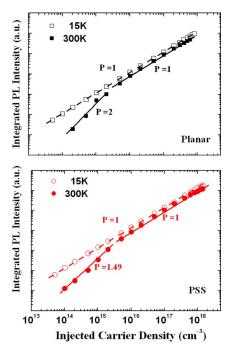


Fig. 3. Integrated PL intensity as function of injected carrier density at 15 and 300 K for both LEDs grown on the planar sapphire substrate (top) and the PSS (bottom).

photon carriers within the active region, as compared to the conventional LED structure grown on planar sapphire substrate. We believe the higher internal quantum efficiency for the LED grown on the PSS is due to the better crystalline quality, attributed to the interaction between stack faults and threading dislocations, as studied in our previous work [15]. We now discuss the mechanism responsible for the dependence of internal quantum efficiency on the injected carrier density for both LEDs grown on planar sapphire substrate and PSS.

In general, the collected PL intensity, L, is proportional to the injected carrier density, I, with a power index P which could be expressed as [16], [17]

$$L\alpha I^P$$
 (2)

where parameter P physically reflects the various recombination processes. If P equals 1, it indicates the radiative recombination dominates. On the other hand, if P>1, the Shockley–Read–Hall recombination occurs, relating to the presence of nonradiative centers that provide a shunt path to the current. Fig. 3 summarized the relationship between injected carrier density and the PL intensity for both LED grown on planar sapphire substrate (top of Fig. 3) and PSS (bottom of Fig. 3).

At 15 K for both samples, the intensity is linearly varied with excitation power density (P=1), which indicates that the radiative recombination dominates the recombination process at all injected carrier density range and the nonradietive centers are quenched at low temperature. However, under low excitation power density at 300 K, the superlinear dependence of L on I is observed for both samples, showing that the defect related nonradiative recombination dominates in this low carrier injection range. But as injected carriers continuously increased, the linear

dependence of the PL intensity to the injected carrier density is exhibited. It must be noted here for both samples in 300 K, the value of P decreases to 1 gradually with the increasing of injected carrier density, instead of jumping from 1.49 to 1 for PSS sample (or 2 to 1 for planar sample). It means the nonradiative centers are saturated and lead to the gradual suppression of the nonradiative recombination with the injected carrier density; therefore, the radiative recombination starts to dominate the recombination process, resulting in the pronounced increasing of the internal quantum efficiency, as shown in Fig. 2, for the region of injected carrier density less than  $10^{17}$  cm<sup>-3</sup>. In addition, since the LED grown on the planar sapphire substrate has higher threading dislocations than that grown on the PSS, the value of P in the superlinear zone is greater for the LED grown on planar sapphire substrate (P = 2) than for the LED grown on PSS (P = 1.49).

To further study the mechanisms responsible for the variation of the internal quantum efficiency in Fig. 2, more optical properties were investigated as below. Fig. 4 shows the emission peak energy and the FWHM of spectra as a function of the injected carrier density at 15 K for both LEDs grown on the planar sapphire substrate [Fig. 4(a)] and the PSS [Fig. 4(b)]. The corresponding carrier lifetime for both samples was also measured and provided in Fig. 4 to support the analysis of carrier dynamics. In Fig. 4(a), for the LED grown on the planar sapphire substrate in 15 K, several unique optical properties were observed. First, the emission peak energy gradually increases with the injected carrier density. Second, the FWHM of spectra shrinks when the injection carrier density ranging from  $5 \times 10^{13} \text{ cm}^{-3}$  to  $1 \times 10^{16} \text{ cm}^{-3}$ , and an opposite trend was observed as the injection carriers further increased. In general, there are two possible mechanisms for the blueshift of emission energy with increasing injected carrier density. The first is coulomb screening of the quantum-confined Stark effect (QCSE). The increasing of injected carrier density weakens the QCSE, and that results in the increasing of transition energy. As the screening effect dominates the emission process, it accompanied a reduction in FWHM. The second is band-filling effect of localized states.

Due to indium composition inhomogeneity and monolayer thickness fluctuation of the InGaN MQWs, self-organized Inrich region is generated in InGaN active region, resulting in potential fluctuation of the energy bandgap [18]-[20]. Further increasing of injected carrier density, the filling effect of high-energetic localized centers starts interfering and becomes dominated; that also induces a blueshift of emission energy. However, unlike the effect of QCSE, this effect accompanies the broadening of FWHM. Clearly, we can conclude that in the region of injected carrier density from  $\sim 5 \times 10^{13} \text{ cm}^{-3}$  to  $\sim 1 \times 10^{16}$  cm<sup>-3</sup>, the gradual increase of emission energy and shrink of FWHM for the LED grown on planar sapphire substrate is mainly due to the coulomb screening of the QCSE, and that increases the overlap probability of wavefunction of electron and hole. Therefore, in the same region of injected carrier density ( $\sim 5 \times 10^{13} \text{ cm}^{-3}$  to  $\sim 1 \times 10^{16} \text{ cm}^{-3}$ ), its internal quantum efficiency also gradually increases, as shown in Fig. 2 (open square). As the injected carrier density is further

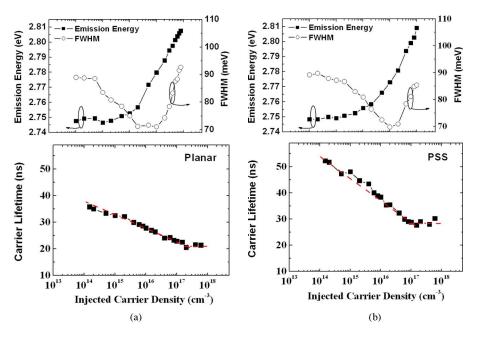


Fig. 4. Emission energy, FWHM and carrier lifetime as a function of injected carrier density at 15 K for the LED grown on (a) the planar sapphire substrate and (b) the PSS.

increased (>  $1 \times 10^{16}~{\rm cm}^{-3}$ ), band filling of localized states starts interfering and becomes dominated; the effect prompts the injected carriers to escape more easily from localized states. As a result, the internal quantum efficiency was further deteriorated with the injected carrier density larger than  $1 \times 10^{16}~{\rm cm}^{-3}$ .

In the bottom of Fig. 4(a), we observed the gradually reduced carrier lifetime with the increasing of the injected carrier density. The decreasing of carrier lifetime with increasing injected carrier density could be attributed to the coulomb screening of internal electric in InGaN MQWs [21]. As injected carrier density in the quantum well (QW) increases, more excited carriers can screen the built-in electric field in QW and that animates the recombination of electron-hole pair. As a result, the carrier recombination rate was accelerated, leading to a decrement of carrier lifetime. For higher injection carrier density  $(> 1 \times 10^{16} \text{ cm}^{-3})$ , we observe that the carrier lifetime keeps decreasing, but a saturated tendency as injected carrier density higher than  $2 \times 10^{17}$  cm<sup>-3</sup>. That is mainly because the carrier at higher state by band-filling effect would have shorter lifetime. And as long as these higher energy states were fully occupied, the corresponding carrier lifetime of emitted photon will keep constant, even with further injection of carrier density. Here, it is clear that our measurement of carrier lifetime well agrees with the shift of main emission peak.

As for the LED grown on the PSS in 15 K [Fig. 4(b)], basically we can adopt the same carrier dynamics to clarify the dependence of emission peak energy and the FWHM on the injected carrier density. However, in the bottom of Fig. 4(b), we observe that under exactly the same injected carrier density, the carrier lifetime of the LED grown on the PSS is around 10 ns longer than that of the LED grown on the planar sapphire substrate. We believe it is due to the fewer threading dislocations in the LED grown on the PSS. In general, the nonradiative recombination rate is much quicker than the radiative recombination

rate, and more nonradiative centers were expected in the LED grown on the planar sapphire substrate. Therefore, in term of the carrier lifetime of emitted photon, the LED grown on the PSS will have longer carrier lifetime than that grown on the planar sapphire substrate. It is also consistent with the evaluation of the internal quantum efficiency in Fig. 2, as one can observe the higher efficiency value on the LED grown on the PSS than that grown on the planar sapphire substrate in 15 K.

To further examine the mechanism responsible for the tendency of the internal quantum efficiency in 300 K, we perform the similar analysis for both LED devices. For the LED grown on the planar sapphire substrate as shown in Fig. 5(a), we could divide three parts of this curve for discussion. At the first glance, the tendency in the region of the injected carrier density from  $\sim 5 \times 10^{15}$  cm<sup>-3</sup> to  $\sim 7 \times 10^{17}$  cm<sup>-3</sup> in Fig. 5(a), is very similar to that at 15 K. Moreover, as compared to the top of Fig. 3 (solid square, 300 K), the parameter P in this region equals 1, indicating the radiative recombination dominates. Therefore, the physical mechanisms of this region can be classified to two stages: 1) the preliminary dominated coulomb screening of the QCSE and 2) the subsequent interfering of band filling effect of localized states.

However, for the initial case of the region with the injected carrier density from  $1\times 10^{14}$  cm<sup>-3</sup> to  $1\times 10^{15}$  cm<sup>-3</sup>, different phenomena were observed. First, in contrast to the results measured at 15 K as shown in Fig. 4(a), the emission energy shows the redshift and the FWHM broadens with increasing injected carrier density. Second, the parameter P in this region equals 2, indicating the nonradiative recombination dominates the carrier recombination process. Third, as compared to Fig. 4(a), it can be found the emission energy at 300 K under low injected carrier density is higher than that at 15 K, which shows that the carriers recombined at higher energy states at 300 K under low injected carrier density condition. Finally, in the bottom

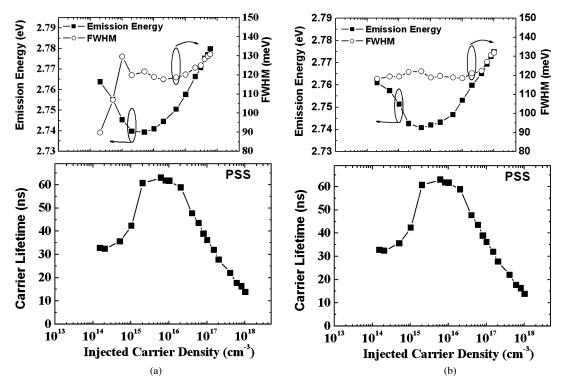


Fig. 5. Emission energy, FWHM and carrier lifetime as a function of injected carrier density at 300 K for the LED grown on (a) the planar sapphire substrate and (b) the PSS.

of Fig. 5(a), the carrier lifetime increases to the maximum of  ${\sim}45$  ns with the injected carrier density from  $1\times10^{14}~\rm cm^{-3}$  to  $1\times10^{15}~\rm cm^{-3}$  and remains unchanged from  $1\times10^{15}~\rm cm^{-3}$  to  $5\times10^{15}~\rm cm^{-3}$ . As further increase the injected carrier density (>  $5\times10^{15}~\rm cm^{-3}$ ), the corresponding carrier lifetime droops gradually.

To summarize the different phenomena mentioned above, at lowest injected carrier density, due to nonradiative process dominates the carrier recombination process (P = 2), the carrier lifetime is shortened and that prompts excited carriers to recombine at higher energy extended states before reaching into lower energy localized states [22]. Thus as compared to the recombination in low-energy localized state in 15 K, the transition of these higher energy extended states would emit higher photon energy. Since there may exist many of higher energy extended states, this kind of recombination would accompany by the broadening of FWHM. Moreover, with the increasing of the injected carrier density from  $1 \times 10^{14}$  cm<sup>-3</sup> to  $1 \times 10^{15}$  cm<sup>-3</sup>, the nonradiative recombination was gradually bleached out and, on the contrary, the radiative process comes to be dominating. Hence, an increment of lifetime was observed in this region [bottom of Fig. 5(a)]. Once the carrier lifetime increases, the excited carriers can transfer from higher extended states to lower localized states and get accompanied with the redshift of emission energy. As a result, in the region of injected carrier density from  $1 \times 10^{14}$  cm<sup>-3</sup> to  $1 \times 10^{15}$  cm<sup>-3</sup> in 300 K, we can expect the higher emission energy than that in 15 K, the redshift of emission energy, the broadening of the FWHM, and the increasing of the carrier lifetime. For the region of the injected carrier density from  $1 \times 10^{15}$  cm<sup>-3</sup> to  $5 \times 10^{15}$  cm<sup>-3</sup>, it could

be seemed as a quasi-equilibrium state of the injected carriers, thus an unchanged of carrier lifetime was observed. After that (>  $5 \times 10^{15}~{\rm cm}^{-3}$ ), similar phenomenon as we discussed in Fig. 4(a) was observed. Therefore, we could conclude that for the LED grown on the planar sapphire substrate, the main mechanism for causing the difference between the internal quantum efficiency curves in 15 and 300 K is the thermal activated non-radiative centers especially at the stage of low injected carrier density. The majority of injected carrier was exhausted by the nonradiative centers and fails to effectively screen the QCSE, resulting in low internal quantum efficiency at 300 K.

In Fig. 5(b), we show the emission energy and the FWHM as function of injected power density at 300 K for the LED grown on the PSS. The corresponding carrier lifetime for the sample is also shown in the bottom of Fig. 5(b). As compared to the sample LED measured in 15 K [Fig. 4(b)], for the injected carrier density from  $1 \times 10^{14}$  cm<sup>-3</sup> to  $1 \times 10^{15}$  cm<sup>-3</sup>, we can observe the higher emission energy, the redshift of emission energy, and the increasing of the carrier lifetime, and that is similar to the previous analysis for the LED grown on the planar sapphire substrate. However, we do not observe the broadening of the FWHM in this region. We believe it is due to the fewer threading dislocations existing in the LED grown the PSS, and thus reduces the transition from higher energy extended states. For the inject carrier density from  $1 \times 10^{15}$  cm<sup>-3</sup> to  $5 \times 10^{15}$  cm<sup>-3</sup>, we also observe the unchanged of the carrier lifetime; however, its maximum carrier lifetime of  $\sim 60$  ns is longer than that of the LED grown on the planar sapphire substrate ( $\sim$ 45 ns). It means fewer nonradiative centers would interfere and affect the transition of injected carriers, and that is well consistent with

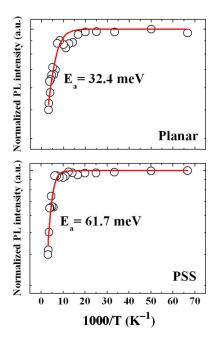


Fig. 6. Normalized integrated PL intensity as a function of 1/T for LEDs grown on the planar sapphire substrate (top) and the PSS (bottom). The activation energy is obtained from the Arrhenius plot.

the experimental observation of FWHM. Again, for the injected carrier density larger than  $5\times 10^{15}~{\rm cm}^{-3}$ , the radiative recombination becomes dominated (P=1) and that would lead to the preliminary coulomb screening of the QCSE and the subsequent band filling effect of localized states as we mentioned before.

Finally, we would like comment briefly on the origin of higher internal quantum efficiency for the LED grown on the PSS. Fig. 6 shows the Arrhenius plot of the normalized integrated PL intensity for both LED grown on the planar sapphire substrate (top of Fig. 6) and the PSS (bottom of Fig. 6) over the temperature range from 15 to 300 K.

The fit activation energy for the LED grown on the planar sapphire substrate and the PSS are 32.4 meV and 61.7 meV, respectively. In general, the activation energy can be explained by the ability to confine the carriers within the potential minima. Thus, the higher value of the activation energy indicates the stronger confinement of injected carriers and that certainly promises the higher internal quantum efficiency.

### IV. SUMMARY

In summary, the physical mechanisms affecting the internal quantum efficiency in InGaN/GaN MQWs LEDs grown on the planar sapphire substrate and the PSS under 15 and 300 K have been studied. At room temperature, the majority of the initial injected carrier was used to suppress the thermal activated nonradiative centers. As the injected carrier density increased, the internal quantum efficiency was improved at the region of screening effect dominated and decreased when band-filling effect dominated. By the comparison of optical properties for both LED samples, to achieve a high internal quantum efficiency GaN-based LED, it would be beneficial to decrease the defect density, weaken the internal electric field in the QW, and

increase the depth of localized states to hinder carriers escaping to extended states. This result would provide a useful guidance to fabricate a high-performance LED with high internal quantum efficiency.

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